

**Vishay Siliconix** 

**BoHS** 

COMPLIAN

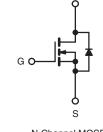


## **Power MOSFET**

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	50			
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = 10 V 0.10			
Q <sub>g</sub> (Max.) (nC)	24			
Q <sub>gs</sub> (nC)	7.1			
Q <sub>gd</sub> (nC)	7.1			
Configuration	Single			







N-Channel MOSFET

#### FEATURES

- For Automatic Insertion
- Compact, End Stackable
- · Fast Switching
- Ease of Paralleling
- Excellent Temperature Stability
- Compliant to RoHS Directive 2002/95/EC

#### DESCRIPTION

The HVMDIP technology is the key to Vishay's advanced line of power MOSFET transistors. The efficient geometry and unique processing of the HVMDIP design achieves very low on-state resistance combined with high transconductance and extreme device ruggedness. HVMDIPs feature all of the established advantages of MOSFETs such as voltage control, very fast switching, ease of paralleling, and temperature stability of the electrical parameters.

The HVMDIP 4 pin, dual-in-line package brings the advantages of HVMDIPs to high volume applications where automatic PC board insertion is desireable, such as circuit boards for computers, printers, telecommunications equipment, and consumer products. Their compatibility with automatic insertion equipment, low-profile and end stackable features represent the stat-of-the-art in power device packaging.

ORDERING INFORMATION	
Package	HVMDIP
Lead (Pb)-free	IRFD020PbF
	SiHFD020-E3
SnPb	IRFD020
	SiHFD020

ABSOLUTE MAXIMUM RATINGS (T $_{\rm C}$	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage <sup>a</sup>			V <sub>DS</sub>	50	- v	
Gate-Source Voltage			V <sub>GS</sub>	± 20		
Continuous Drain Current	$\lambda$ of 10 $\lambda$	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	- I <sub>D</sub>	2.4		
Continuous Drain Current	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C		1.5	А	
Pulsed Drain Current <sup>b</sup>			I <sub>DM</sub>	19	1	
Linear Derating Factor				0.0080	W/°C	
Inductive Current, Clamped	L = 100 µH		I <sub>LM</sub>	19	Λ	
Unclamped Inductive Current (Avalanche Current) <sup>c</sup>		۱ <sub>L</sub>	2.2	- A		
Maximum Power Dissipation	T <sub>C</sub> = 25 °C		PD	1.0	W	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	°C		
Soldering Recommendations (Peak Temperature)	for 10 s			300 <sup>d</sup>		

#### Notes

a.  $T_J = 25 \degree C$  to 150  $\degree C$ 

b. Repetitive rating; pulse width limited by maximum junction temperature.

c.  $V_{DD}$  = 25 V, starting  $T_J$  = 25 °C, L = 100  $\mu H,\,R_g$  = 25  $\Omega$ 

d. 1.6 mm from case.

\* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP		MAX.			UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	- 120			°C/W			
<b>SPECIFICATIONS</b> ( $T_C = 25 \text{ °C}$ , u	inless otherw	ise noted)				•		
PARAMETER	SYMBOL	TES		ONS	MIN.	TYP.	MAX.	UNIT
Static								-
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 2	50 µA	50	-	-	V
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 2	250 μA	2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>	,	$V_{GS} = \pm 20$	V	-	-	± 500	nA
Zere Cata Valtaga Drain Current	1	$V_{DS}$ = max. rating, $V_{GS}$ = 0 V			-	-	250	
Zero Gate Voltage Drain Current	IDSS	$V_{DS}$ = max. rating x 0.8, $V_{GS}$ = 0 V, $T_{C}$ = 125		-	-	1000	μA	
On-State Drain Current <sup>b</sup>	I <sub>D(on)</sub>	$V_{GS} = 10 V$	$V_{DS} > I_{D(or)}$	n) x R <sub>DS(on)</sub> max.	2.4	-	-	Α
Drain-Source On-State Resistance <sup>b</sup>	R <sub>DS(on)</sub>	$V_{GS} = 10 \text{ V}$	I <sub>D</sub>	= 1.4 A	-	0.080	0.10	Ω
Forward Transconductance <sup>b</sup>	9 <sub>fs</sub>	V <sub>DS</sub> :	= 20 V, I <sub>D</sub> =	7.5 A	4.9	7.3	-	S
Dynamic		•						
Input Capacitance	C <sub>iss</sub>		$V_{ee} = 0.V$		-	400	-	
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 V, V_{DS} = 25 V, f = 1.0 MHz - 260 - f = 44 - $					-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>		f = 1.0 MHz	2	-	44	-	
Total Gate Charge	Qg				-	16	24	
Gate-Source Charge	$Q_gs$	$V_{GS} = 10 V$		= 15 A, ax. rating x 0.8	-	4.7	7.1	nC
Gate-Drain Charge	Q <sub>gd</sub>		105 - 110		-	4.7	7.1	
Turn-On Delay Time	t <sub>d(on)</sub>		•		-	8.7	13	
Rise Time	t <sub>r</sub>	Vaa	– 25 V I. –	15 Δ	-	55	83	
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{DD}$ = 25 V, I <sub>D</sub> = 15 A, R <sub>g</sub> = 18 Ω, R <sub>D</sub> = 1.7 Ω		-	16	24	ns	
Fall Time	t <sub>f</sub>				-	26	39	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.0	-		
Internal Source Inductance	L <sub>S</sub>			-	6.0	-	nH	
Drain-Source Body Diode Characteristic	s	·						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET sym showing the			-	-	2.4	
Pulsed Diode Forward Current <sup>c</sup>	I <sub>SM</sub>	integral revers p - n junction			-	-	19	A
Body Diode Voltage <sup>a</sup>	V <sub>SD</sub>	T <sub>C</sub> = 25 °C	C, I <sub>S</sub> = 2.4 A	, V <sub>GS</sub> = 0 V	-	-	1.4	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T 05.00 -		44 100 0 / -	57	130	310	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>J</sub> = 25 °C, I <sub>F</sub>	= = 15 A, dl/	′dt = 100 A/µs	0.17	0.34	0.85	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic tu	Irn-on time i	is negligible (turn	on is dor	ninated b	y L <sub>S</sub> and	L <sub>D</sub> )

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

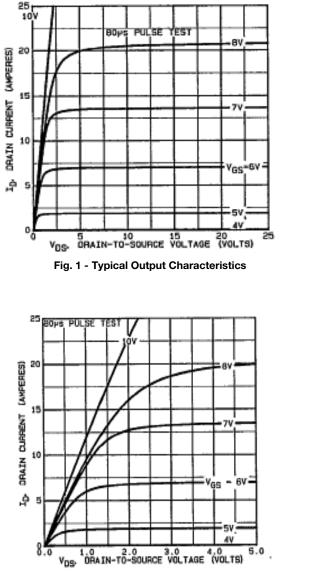
b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %.

c.  $V_{DD}$  = 25 V, starting  $T_J$  = 25 °C, L = 100  $\mu H,\,R_g$  = 25  $\Omega$ 

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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Fig. 2 - Typical Output Characteristics

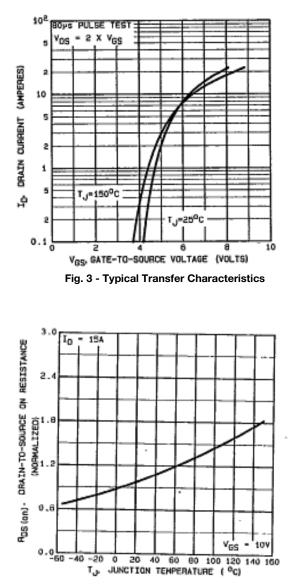


Fig. 4 - Normalized On-Resistance vs. Temperature

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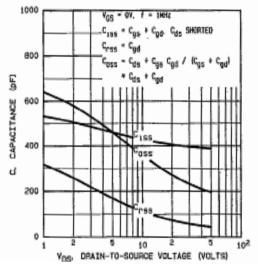


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

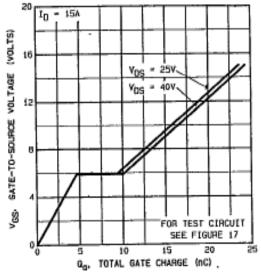


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

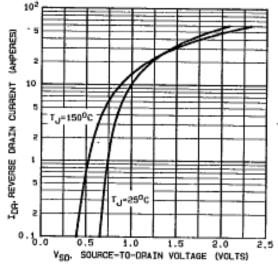
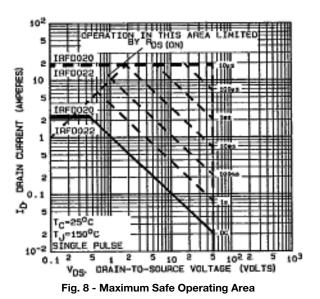


Fig. 7 - Typical Source-Drain Diode Forward Voltage



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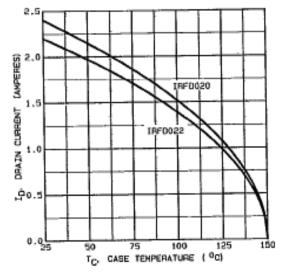
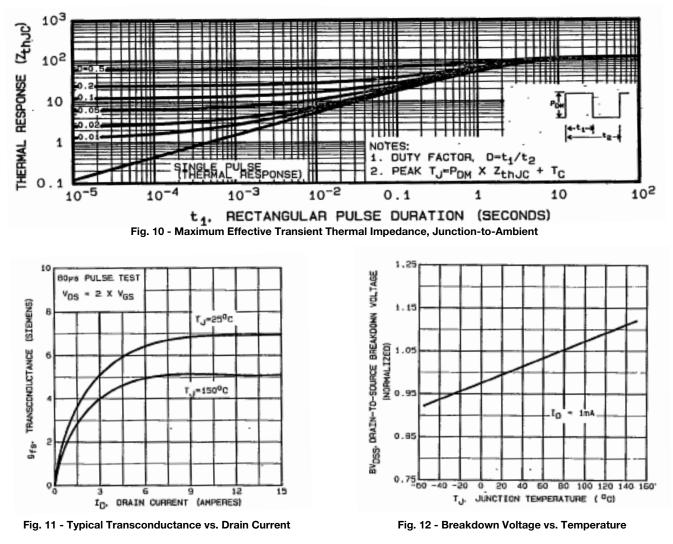


Fig. 9 - Maximum Drain Current vs. Ambient Temperature



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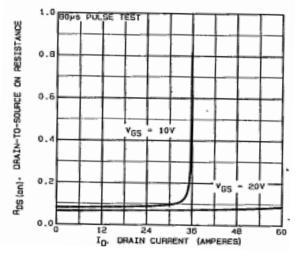


Fig. 13 - Typical on-Resistance vs. Drain Current

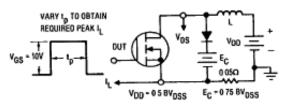


Fig. 14a - Clamped Inductive Test Circuit

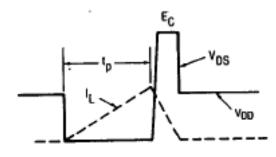


Fig. 14b - Clamped Inductive Waveforms

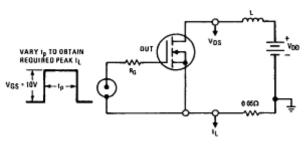


Fig. 15a - Unclamped Inductive Test Circuit

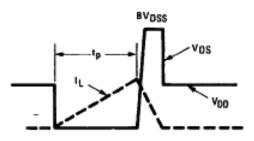


Fig. 15a - Unclamped Inductive Load Test Waveforms

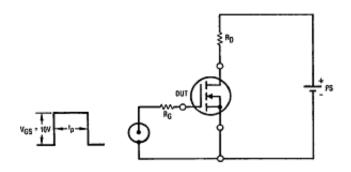


Fig. 16 - Switching Time Test Circuit

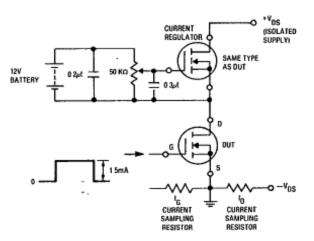


Fig. 17 - Gate Charge Test Circuit

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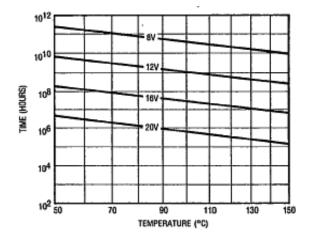


Fig. 18 - Typical Time to Accumulated 1 % Gate Failure

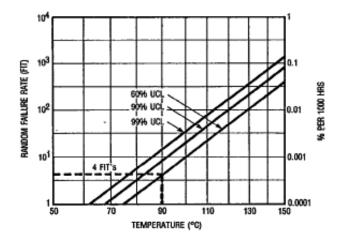


Fig. 19 - Typical High Temperature Reverse Bias (HTRB) Failure Rate

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <u>www.vishay.com/ppg291465</u>.

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### HVM DIP (High voltage)





	INCHES		MILLIN	IETERS
DIM.	MIN.	MAX.	MIN.	MAX.
А	0.310	0.330	7.87	8.38
E	0.300	0.425	7.62	10.79
L	0.270	0.290	6.86	7.36
ECN: X10-0386-Rev. B, 0 DWG: 5974	06-Sep-10			

Note

1. Package length does not include mold flash, protrusions or gate burrs. Package width does not include interlead flash or protrusions.



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